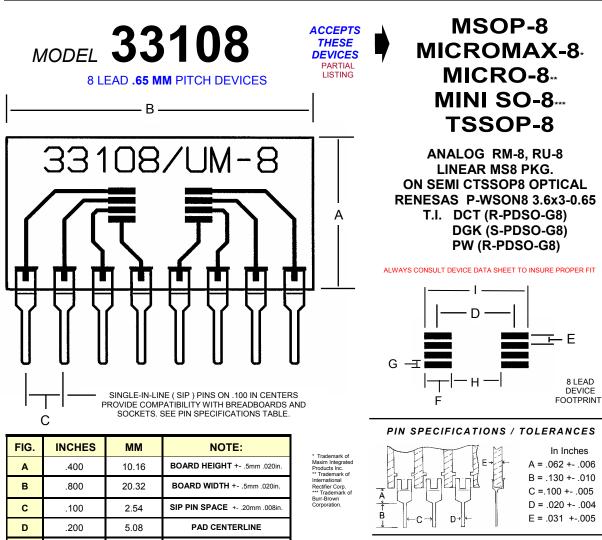




REV 1-2012

THE BREADBOARDING MEDIUM FOR **SURFACE MOUNT** TM

IDS33108 33000 SERIES APPLICATION SPECIFIC ADAPTERS



BOARD SPECIFICATIONS

BOARD MATERIAL: .8mm. +-.13mm .031in+-..005 in. Thick G-10 FR-4 Glass Epoxy or equivalent. CIRCUITS: 1 oz. Copper with RoHS compliant Lead Free solder coating. Patten Position on board +-.5mm .020in.

TOLERANCES: If not noted are +- 20%. Nominal values are given Controlling unit is Millimeters. Values rounded to nearest decimal. Slight Variations due to manufacturing process can occur.

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CAPITAL ADVANCED TECHNOLOGIES, INC.

CAROL STREAM, ILLINOIS . USA.

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DEVICE LEAD PITCH

PAD LENGTH

PAD WIDTH

GAP

MAX LEAD WIDTH

WWW.CapitalAdvanced.Com

FAX 630-690-2498